

SEMISTART

Antiparallel thyristors for softstart

SKKQ 1500/14E

Features

- · Compact design
- Thyristor with amplifying gate
- Pressure contact technology

Typical Applications*

Soft starters

Remarks

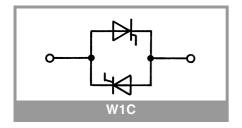
- Please note: This module has no soft mold protection around the chip. It is therefore susceptible to environmental influences (dust, humidity, etc.). The humidity test according to IEC60068-2-67 is not passed by this product.
- Recommendation: The devices should be installed in control cabinets of IP54 degree of protection.

Footnotes

 $^{1)}\,T_{jmax}$ up to 150°C is allowable for overload conditions, max. time period for the overload condition is 20s.

Absolute Maximum Ratings								
Symbol	Conditions		Values	Unit				
Module	·							
I _{overload}	W1C, sin. 180°, 20 s, T _{jmax} = 150 °C, T _{jstart} = 40 °C		1500	А				
I _{TSM}	10 ms	T _j = 25 °C	17000	Α				
	101115	T _j = 125 °C	15000	Α				
i ² t	10 ms	T _j = 25 °C	1445000	A ² s				
		T _j = 125 °C	1125000	A ² s				
V_{RSM}		<u> </u>	1500	V				
V_{RRM} V_{DRM}			1400	V				
Tj	1)		-40 + 125 °					
T _{stg}			-40 + 125	°C				

Characteristics								
Symbol	Conditions	min.	typ.	max.	Unit			
V_{T}	$T_j = 25 ^{\circ}\text{C}, I_T = 1700 \text{A}$			1.5	V			
$V_{T(TO)}$	T _j = 125 °C			0.85	V			
r _T	T _j = 125 °C			0.3	mΩ			
$I_{DD};I_{RD}$	$T_j = 125$ °C, $V_{RD}=V_{RRM}$, per module			190	mA			
t _{gd}	$T_j = 25$ °C, $I_G = 1$ A, $di_G/dt = 1$ A/ μs		1		μs			
t _{gr}	$V_{D} = 0.67 * V_{DRM}$		2		μs			
(dv/dt) _{cr}	T _j = 125 °C		1000		V/µs			
(di/dt) _{cr}	T _j = 125 °C, f = 50 60 Hz		200		A/μs			
t _q	T _j = 125 °C		200		μs			
I _H	T _j = 25 °C		150	500	mA			
IL	$T_j = 25$ °C, $R_G = 33 \Omega$		300	2000	mA			
V_{GT}	T _j = 25 °C, d.c.	3			V			
I _{GT}	T _j = 25 °C, d.c.	200			mA			
V_{GD}	T _j = 125 °C, d.c.			0.25	V			
I _{GD}	T _j = 125 °C, d.c.			10	mA			
R _{th(j-r)}	continuous DC, per thyristor			0.037	K/W			
Mt	to terminals	4.25		5.75	Nm			
m	approx.		1200		g			
Case			2					



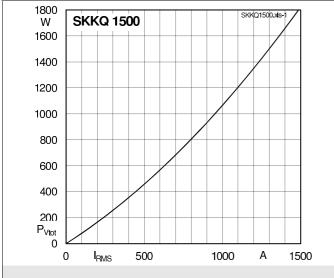


Fig. 1: Power dissipation per module vs. rms current

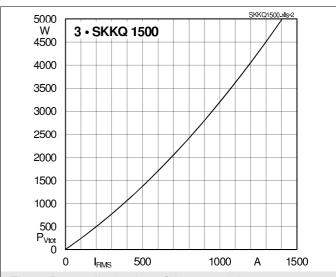


Fig. 2: Power dissipation of three modules vs. rms current

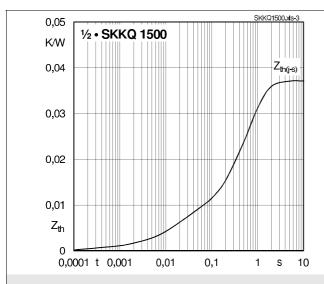


Fig. 3: Transient thermal impedance $Z_{\text{th(j-r)}}$ vs. time

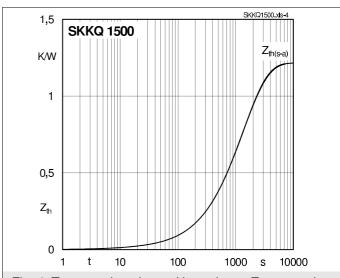


Fig. 4: Typ. transient thermal impedance $Z_{\text{th(s-a)}}$ vs. time (natural cooling)

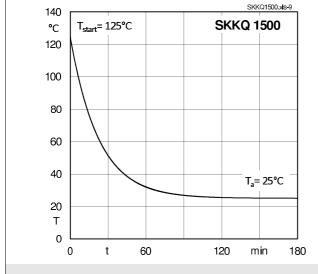


Fig. 5: Typ. cooling down vs. time (natural cooling)

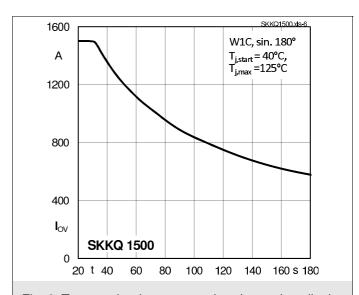
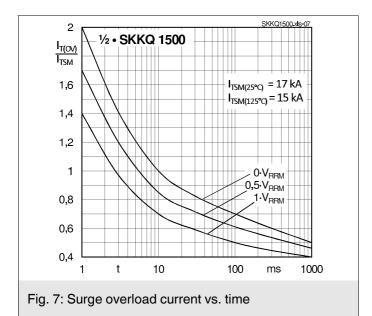
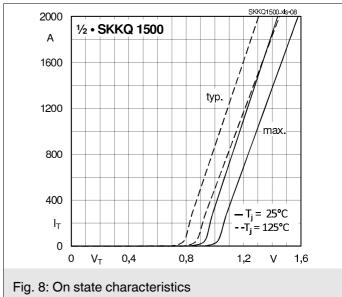
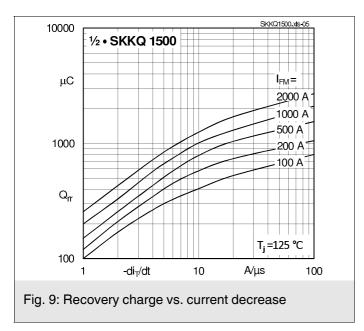
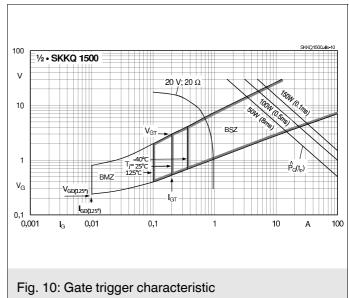


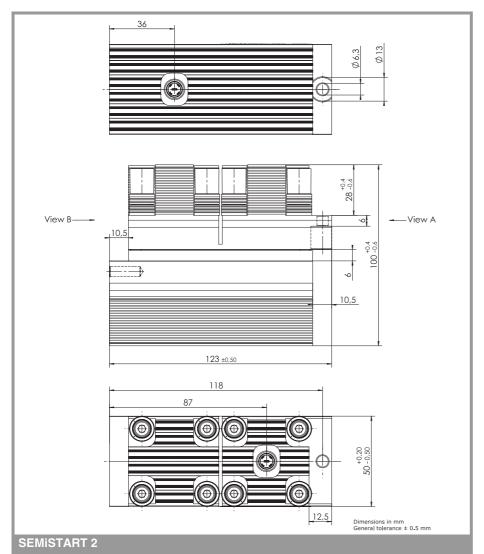
Fig. 6: Typ. overload current vs. time (natural cooling)

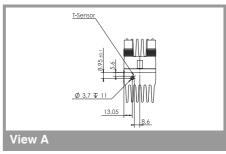


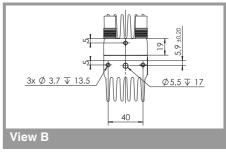












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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